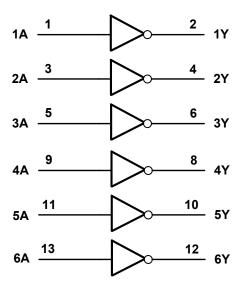


# **Pin Descriptions**

Pin Number	Pin Name	Function
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	3A	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	Vcc	Supply Voltage

## **Logic Diagram**



# **Function Table**

Input	Output
Α	Y
Н	L
L	Н



## Absolute Maximum Ratings (Note 4) (@TA = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	ESD HBM Human Body Model ESD Protection		KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V <sub>CC</sub>	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range (Note 5)	-0.5 to +7.0	V
l <sub>IK</sub>	Input Clamp Current $V_1 < -0.5V$ or $V_1 > V_{CC} +0.5V$	±20	mA
I <sub>OK</sub>	Output Clamp Current $V_O < -0.5V$ or $V_O > V_{CC} +0.5V$	±20	mA
Io	Continuous Output Current -0.5V < V <sub>O</sub> V <sub>CC</sub> +0.5V	+/- 25	mA
Icc	Continuous Current Through Vcc	50	mA
I <sub>GND</sub>	Continuous Current Through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	T <sub>STG</sub> Storage Temperature		°C
P <sub>TOT</sub>	Total Power Dissipation	500	mW

Notes:

## Recommended Operating Conditions (Note 6) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		4.5	5.5	V
VI	Input Voltage		0	Vcc	V
Vo	Output Voltage		0	V <sub>CC</sub>	V
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 4.5V$ to 5.5V	_	500	ns/V
T <sub>A</sub>	Operating Free-Air Temperature		-40	+125	°C

Note: 6. Unused inputs should be held at  $V_{CC}$  or Ground.

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	Vcc	T <sub>A</sub> = -40°C	to +85°C	T <sub>A</sub> = -40°C	to +125°C	Unit
Syllibol	Parameter	rest Conditions	V CC	Min	Max	Min	Max	Ullit
V <sub>IH</sub>	High-Level Input Voltage		4.5V to 5.5V	2.0		2.0	_	V
V <sub>IL</sub>	Low-Level Input Voltage		4.5V to 5.5V	_	0.8	_	0.8	V
	High-Level Output	I <sub>OH</sub> = -20μA	4.5V	4.4	_	4.4	_	V
V <sub>OH</sub>	Voltage	I <sub>OH</sub> = -4mA	4.5V	3.80	_	3.70	_	]
	Low-Level Output	I <sub>OL</sub> = 20μA	4.5V	_	0.1	_	0.1	V
V <sub>OL</sub>	Voltage	I <sub>OL</sub> = 5.2mA	6.0V	_	0.33	_	0.4	V
lı	Input Current	V <sub>I</sub> = GND to 6.0V	6.0V	_	± 1	_	± 1	μA
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}, I_O = 0$	6.0V	_	20	_	40	μA
ΔI <sub>CC</sub>	Additional Supply Current	One input at V <sub>CC</sub> -2.1V Other pins at V <sub>CC</sub> or GND	4.5V to 5.5V	_	675	_	735	μA

<sup>4.</sup> Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

<sup>5.</sup> Input Voltage cannot exceed  $V_{\text{CC}}$  to the extent the Maximum clamp current is exceeded.



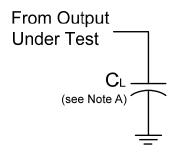
#### **Switching Characteristics**

Symbol	Parameter	Test	V	7	Γ <sub>A</sub> = +25°(	<b>)</b>	-40°C to +85°C	-40°C to +125°C	Unit
Syllibol	Farameter	Conditions	V <sub>CC</sub>	Min	Тур	Max	Max	Max	Oilit
t <sub>PD</sub>	Propagation Delay A <sub>N</sub> to Y <sub>N</sub>	Figure 1 C <sub>L</sub> = 50pF	4.5V	_	12	22	24	29	ns
t <sub>t</sub>	Transition time	Figure 1 C <sub>L</sub> = 50pF	4.5V	_	7	29	29	29	ns

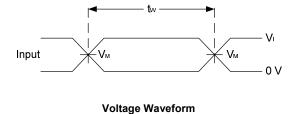
## Operating Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter		Test Conditions	V <sub>CC</sub> = 5.5V Typ	Unit
C <sub>pd</sub>	Power Dissipation Capacitance per Gate	f = 1MHz	22	pF
Cı	Input Capacitance	$V_I = V_{CC} - \text{ or GND}$	4	pF

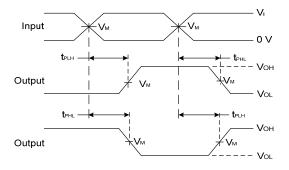
# Parameter Measurement Information



Vcc	Inp	uts	V <sub>M</sub>	CL
	VI	t <sub>r</sub> /t <sub>f</sub>		
4.5V	3.0V	3ns	1.5V	V <sub>OH</sub> /2



**Pulse Duration** 



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

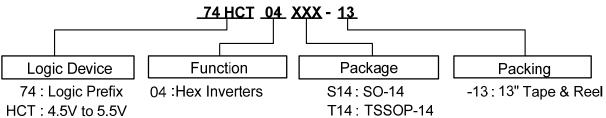
Notes: A.Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 1 MHz
- C. Inputs are measured separately one transition per measurement
- D.  $t_{\text{PLH}}$  and  $t_{\text{PHL}}$  are the same as  $t_{\text{PD}}$

Figure 1 Load Circuit and Voltage Waveforms



#### **Ordering Information**

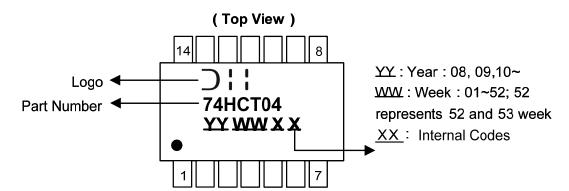


HCT: 4.5V to 5.5V Family

	Device	Package Code	Packaging	7" Tape	and Reel
	Device	Package Code	Packaging	Quantity	Part Number Suffix
Pb, nad-free Green	74HCT04S14-13	S14	SO-14	2500/Tape & Reel	-13
<b>Pb</b> ,	74HCT04T14-13	T14	TSSOP-14	2500/Tape & Reel	-13

## **Marking Information**

#### (1) SO-14, TSSOP-14



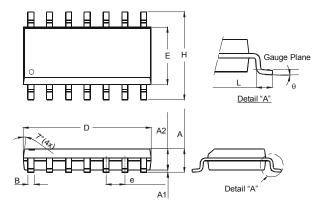
Part Number	Package
74HCT04S14	SO-14
74HCT04T14	TSSOP-14



## Package Outline Dimensions (All dimensions in mm.)

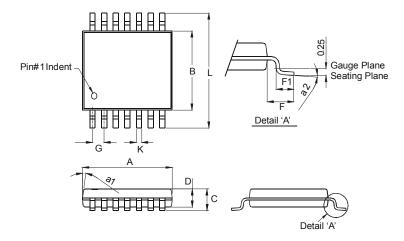
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

#### Package Type: SO-14



	SO-14					
Dim	Min	Max				
Α	1.47	1.73				
<b>A</b> 1	0.10	0.25				
A2	1.45	Тур				
В	0.33	0.51				
D	8.53	8.74				
Е	3.80	3.99				
е	1.27	Тур				
Н	5.80	6.20				
L	0.38	1.27				
θ	0°	8°				
All Dimensions in mm						

#### Package Type: TSSOP-14



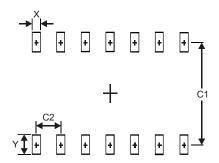
TSSOP-14						
Dim	Min	Max				
a1	7° (	4X)				
a2	0°	8°				
Α	4.9	5.10				
В	4.30	4.50				
С	_	1.2				
D	0.8	1.05				
F	1.00	Тур				
F1	0.45	0.75				
G	0.65 Typ					
K	0.19	0.30				
Ĺ	6.40 Typ					
All Dimensions in mm						



# **Suggested Pad Layout**

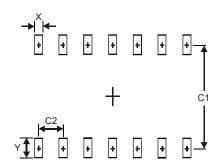
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.

#### Package Type: SO-14



Dimensions	Value (in mm)
Х	0.60
Υ	1.50
C1	5.4
C2	1 27

#### Package Type: TSSOP-14



Value (in mm)
0.45
1 45
5.9
0.65

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